

ESDA14V2-2BF3

Quad bidirectional Transil[™] array for ESD protection

Features

- 2 bidirectional Transil functions
- ESD protection: IEC 61000-4-2 level 4
- Stand off voltage: 12 V Min.
- Low leakage current
- Very small PCB area < 1.5 mm²
- 400 microns pitch

Complies with the following standards

- IEC 61000-4-2
 - 15 kV (air discharge)
 - 8 kV (contact discharge)
- MIL STD 883E- Method 3015-7: class 3
 25 kV (human body model)

Applications

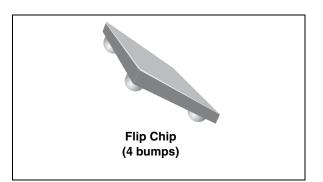
Where transient overvoltage protection in ESD sensitive equipment is required, such as:

- Computers
- Printers
- Communication systems and cellular phones
- Video equipment

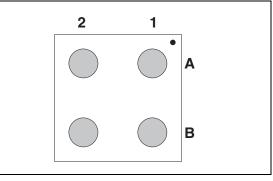
Description

The ESDA14V2-2BF3 is a monolithic array designed to protect 2 lines against ESD transients. The device is ideal for applications where both reduced line capacitance and board space saving are required.

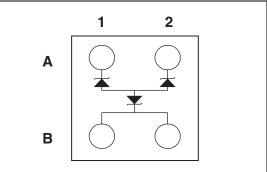
This device is particularly adapted to the protection of symmetrical signals.











TM: Transil is ASD a trademark of STMicroelectronics.

Characteristics 1

Symbol	F	Value	Unit		
	Ν	MIL STD 883E - Method 3015-7	± 25		
V _{PP}	ESD discharge	EC 61000-4-2 air discharge	± 15	kV	
	I	EC 61000-4-2 contact discharge	± 8		
P _{PP}	Peak pulse power (8/20µs	50	W		
Тj	Junction temperature	125	°C		
T _{stg}	Storage temperature rang	-55 to +150	°C		
TL	Lead solder temperature (260	°C		
T _{op}	Operating temperature rar	-40 to +125	°C		

Table 1. Absolute ratings (limiting values)

Electrical characteristics (T_{amb} = 25 °C) Table 2.

Symbol	Parameter					I †		
V _{BR}	Breakdown voltage							
I _{RM}	Leakage current @ V _{RM}							
V _{RM}	Stand-off voltage							
V _{CL}	Clamping voltage		V _{CL} V _{BR} V _{RM} → V					
R _d	Dynamic impedance							
I _{PP}	Peak pulse current							
αΤ	Voltage temperature coefficient	Slope: 1 / R _d			Ірр			
С	Capacitance							
	V _{BR} @ I _R	I _{RM} @ V _{RM} Rd at		С				
Order code	min.	max		max.		typ. ⁽¹⁾	max. ⁽²⁾	max. 0 V bias
	V	V	mA	μA	V	Ω	10 ⁻⁴ /C	pF
ESDA14V2-2BF3	3 14.2		1	0.5 0.1	12 3	3.2	6.5	12

1. Square pulse, $I_{pp} = 3 \text{ A}$, $t_p = 2.5 \ \mu\text{s}$. 2. $\Delta V_{BR} = \alpha T^* (T_{amb} - 25 \ ^\circ\text{C}) * V_{BR} (25 \ ^\circ\text{C})$



Figure 3. Relative variation of peak pulse power versus intial junction temperature

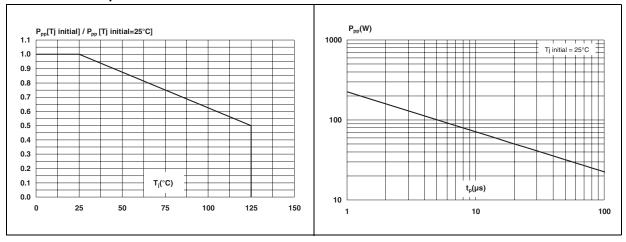
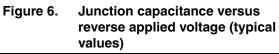


Figure 5. Clamping voltage versus peak pulse current (typical values, rectangular waveform)



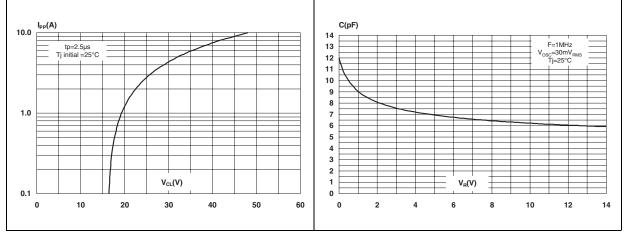
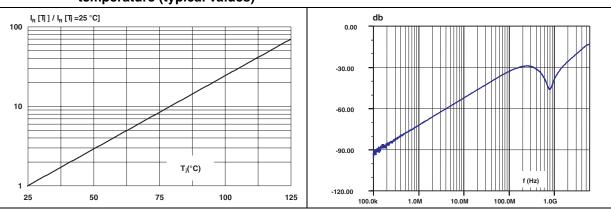


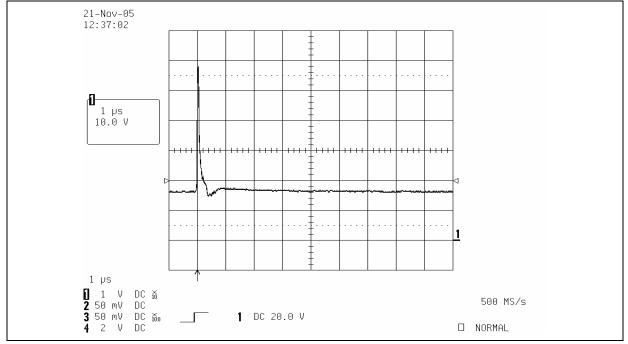
Figure 4. Peak pulse power versus exponential pulse duration

Figure 7. Relative variation of leakage current versus junction temperature (typical values)











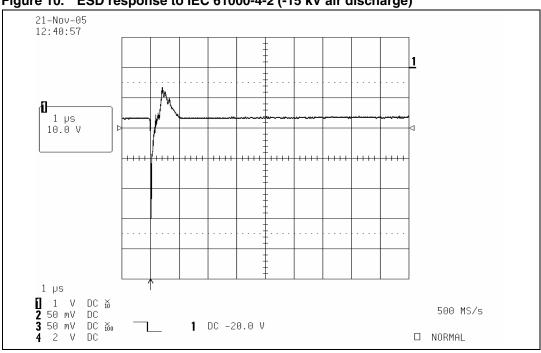
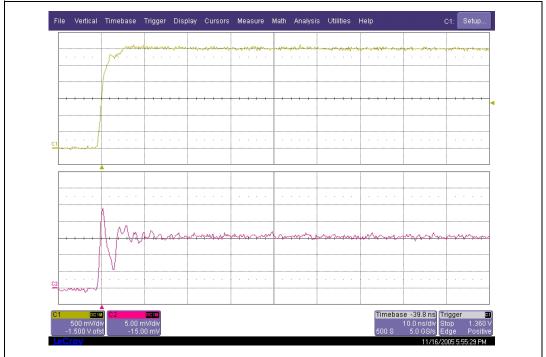


Figure 10. ESD response to IEC 61000-4-2 (-15 kV air discharge)

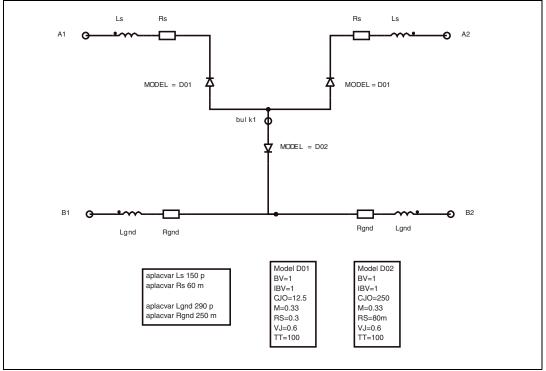
Figure 11. Digital crosstalk measurement





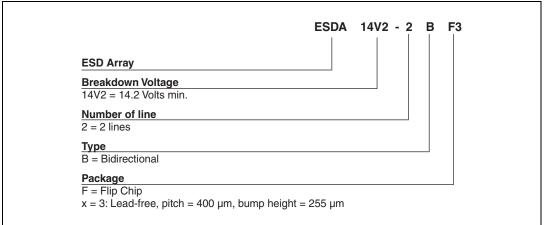
2 Application information





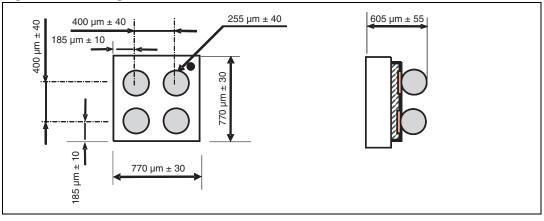
3 Ordering information scheme

Figure 13. Ordering information scheme



4 Package information

In order to meet environmental requirements, ST offers these devices in ECOPACK[®] packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at *www.st.com*.





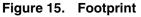
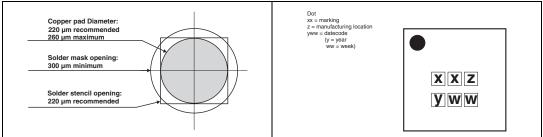


Figure 16. Marking





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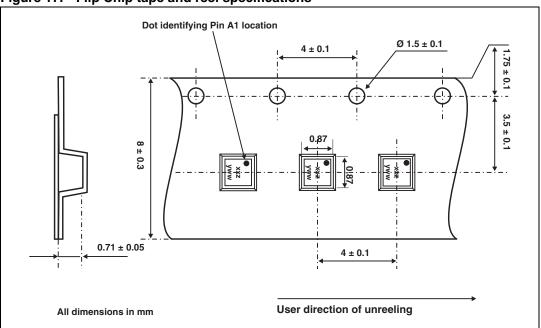


Figure 17. Flip Chip tape and reel specifications

Note:

More information is available in the application note: AN2348 :"400 μm Flip Chip: Package description and recommendations for use" AN1751 : EMI Filters: Recommendations and measurements

5 Ordering information

Table 3.	Ordering	information
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Order code	Marking	Package	Weight	Base qty	Delivery mode
ESDA14V2-2BF3	EG	Flip Chip	0.79 mg	5000	Tape and reel 7"

6 Revision history

Table 4.	Document revision history
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Date	Revision	Changes
02-Dec-2005	1	Initial release.
15-Dec-2005	2	Ordering information changed.
29-Apr-2008	3	Updated ECOPACK statement. Updated <i>Figure 13</i> and <i>Figure 17</i> . Reformatted to current standards.



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